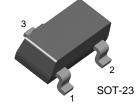


## **KSC3123**

### **Mixer for UHF TV Tuner**

- G<sub>CE</sub>=23dB
  C<sub>RE</sub>=0.4pF



1. Base 2. Emitter 3. Collector

## **NPN Epitaxial Silicon Transistor**

### **Absolute Maximum Ratings** T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CBO}$	Collector-Base Voltage	30	V
$V_{CEO}$	Collector-Emitter Voltage	20	V
V <sub>EBO</sub>	Emitter-Base Voltage	3	V
I <sub>C</sub>	Collector Current	50	mA
I <sub>B</sub>	Base Current	25	mA
P <sub>C</sub>	Collector Power Dissipation	150	mW
T <sub>J</sub>	Junction Temperature	1500	°C
T <sub>STG</sub>	Storage Temperature	-55 ~ 150	°C

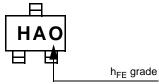
### Electrical Characteristics T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> =1mA, I <sub>B</sub> =0	20			V
I <sub>CBO</sub>	Collector Cut-off Current	$V_{CB}$ =25V, $I_{E}$ =0			0.1	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB}$ =3V, $I_{C}$ =0			1	μΑ
h <sub>FE</sub>	DC Current Gain	V <sub>CE</sub> =10V, I <sub>C</sub> =5mA	60		240	
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> =10V, I <sub>C</sub> =5mA	900	1400		MHz
C <sub>RE</sub>	Reverse Transfer Capacitance	V <sub>CB</sub> =10V, I <sub>E</sub> =0, f=1MHz		0.4	0.5	pF
G <sub>CE</sub>	Conversion Gain	V <sub>CC</sub> =12V, f=200MHz f <sub>L</sub> =260MHz	20	23		dB
NF	Output Capacitance	V <sub>CE</sub> =12V, f=200MHz, f <sub>L</sub> =260MHz		3.8	5.5	dB

### **h**<sub>FE</sub> Classification

Classification	R	0	Y
h <sub>FE</sub>	60 ~ 120	90 ~ 180	120 ~ 240

Marking



# **Typical Characteristics**

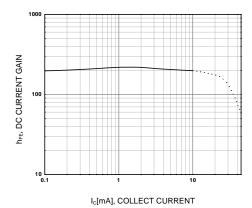


Figure 1. DC current Gain

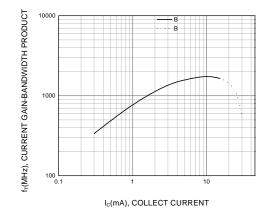
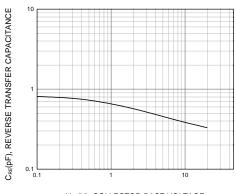


Figure 2. Current Gain Bandwidth Product



 $V_{\text{CB}}(V),\,\text{COLLECTOR-BASE}\,\,\text{VOLTAGE}$ 

Figure 3.  $C_{RE}$ - $V_{CB}$ 

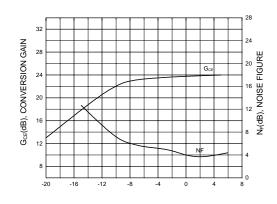


Figure 4. G<sub>CE</sub>, NF-

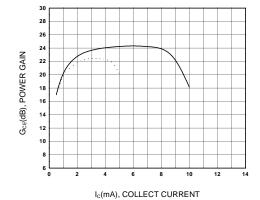


Figure 5. G<sub>CE</sub>-I<sub>C</sub>

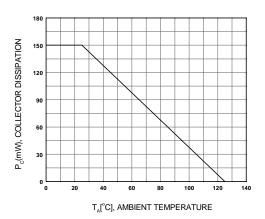
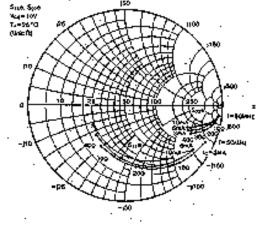


Figure 6.  $P_C$ - $T_A$ 

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# Typical Characteristics (Continued)



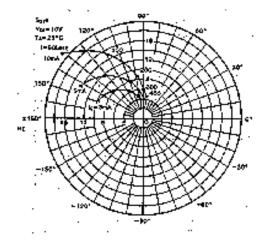


Figure 7.

Figure 8.

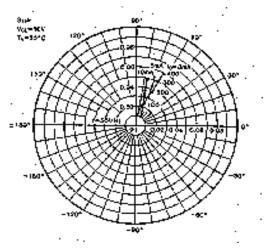
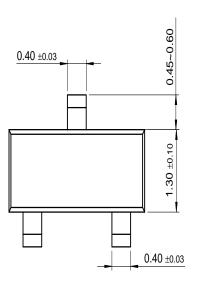
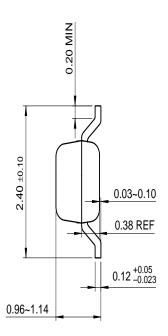


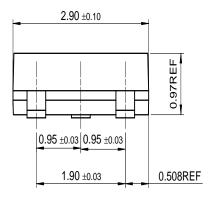
Figure 9.

# **Package Demensions**

## **SOT-23**







Dimensions in Millimeters

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